

TOSHIBA Field-Effect Transistor Silicon N-Channel MOS Type

SSM3K35CT

○ High-Speed Switching Applications

○ Analog Switch Applications

- 1.2-V drive
- Low ON-resistance : $R_{on} = 20 \Omega$ (max) (@ $V_{GS} = 1.2$ V)
 $R_{on} = 8 \Omega$ (max) (@ $V_{GS} = 1.5$ V)
 $R_{on} = 4 \Omega$ (max) (@ $V_{GS} = 2.5$ V)
 $R_{on} = 3 \Omega$ (max) (@ $V_{GS} = 4.0$ V)

Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

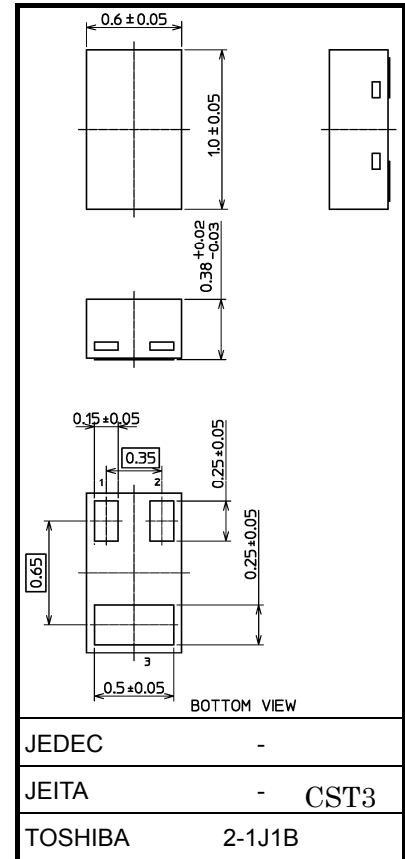
Characteristics		Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	20	V
Gate-source voltage		V_{GSS}	± 10	V
Drain current	DC	I_D	180	mA
	Pulse	I_{DP}	360	
Drain power dissipation		P_D (Note 1)	100	mW
Channel temperature		T_{ch}	150	$^\circ\text{C}$
Storage temperature		T_{stg}	-55 to 150	$^\circ\text{C}$

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

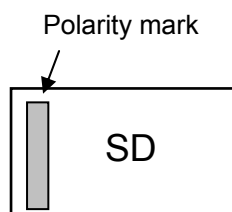
Note 1: Mounted on an FR4 board
 (10 mm $\times$ 10 mm $\times$ 1.0 mm, Cu Pad: 100 mm²)

Unit: mm

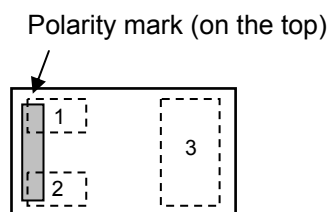


Weight: 0.75 mg (typ.)

Marking (top view)

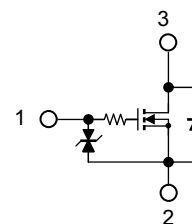


Pin Condition (top view)



1. Gate
 2. Source
 3. Drain
- *Electrodes: on the bottom

Equivalent Circuit (top view)



Start of commercial production
 2008-02

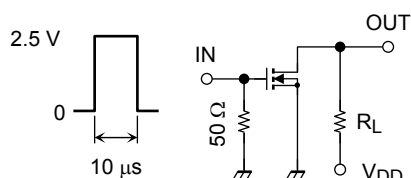
Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		I _{GSS}	V _{GS} = ±10 V, V _{DS} = 0V	—	—	±10	μA
Drain–source breakdown voltage		V _(BR) DSS	I _D = 0.1 mA, V _{GS} = 0V	20	—	—	V
Drain cutoff current		I _{DSS}	V _{DS} = 20 V, V _{GS} = 0V	—	—	1	μA
Gate threshold voltage		V _{th}	V _{DS} = 3 V, I _D = 1 mA	0.4	—	1.0	V
Forward transfer admittance		Y _{fs}	V _{DS} = 3 V, I _D = 50 mA (Note 2)	115	—	—	mS
Drain–source ON-resistance		R _{DS} (ON)	I _D = 50 mA, V _{GS} = 4 V (Note 2)	—	1.5	3	Ω
			I _D = 50 mA, V _{GS} = 2.5 V (Note 2)	—	2	4	
			I _D = 5 mA, V _{GS} = 1.5 V (Note 2)	—	3	8	
			I _D = 5 mA, V _{GS} = 1.2 V (Note 2)	—	5	20	
Input capacitance		C _{iss}	V _{DS} = 3 V, V _{GS} = 0V, f = 1 MHz	—	9.5	—	pF
Reverse transfer capacitance		C _{rss}		—	4.1	—	
Output capacitance		C _{oss}		—	9.5	—	
Switching time	Turn-on time	t _{on}	V _{DD} = 3 V, I _D = 50 mA, V _{GS} = 0 to 2.5 V	—	115	—	ns
	Turn-off time	t _{off}		—	300	—	
Drain–source forward voltage		V _{DSF}	I _D = - 180 mA, V _{GS} = 0V (Note 2)	—	-0.9	-1.2	V

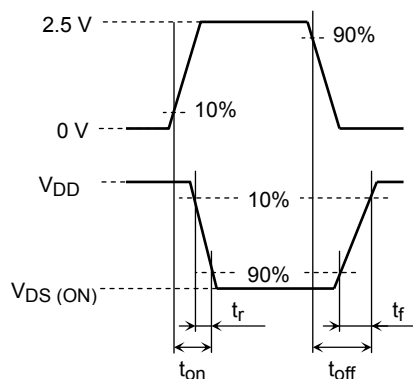
Note 2: Pulse test

Switching Time Test Circuit

(a) Test Circuit



$V_{DD} = 3\text{ V}$
 Duty $\leq 1\%$
 V_{IN} : $t_r, t_f < 5\text{ ns}$
 $(Z_{out} = 50\ \Omega)$
 Common Source
 $T_a = 25^\circ\text{C}$

(b) V_{IN} (c) V_{OUT}

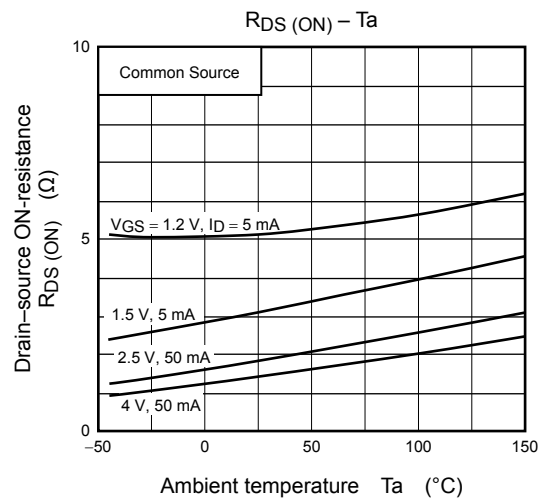
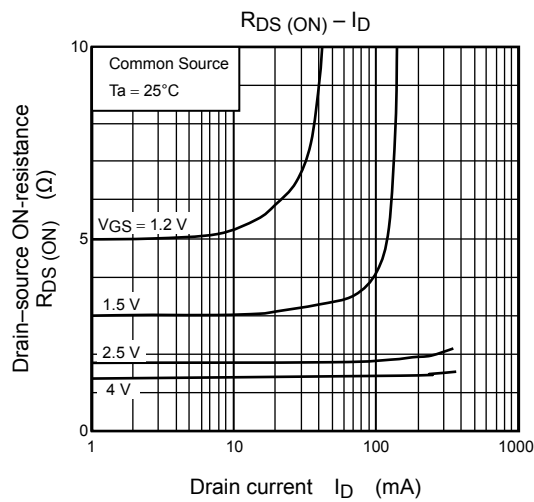
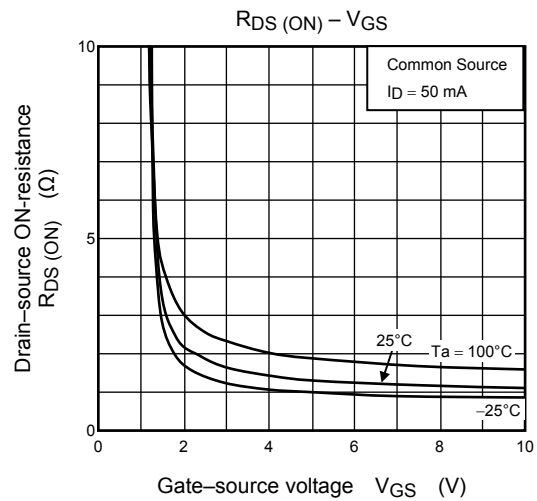
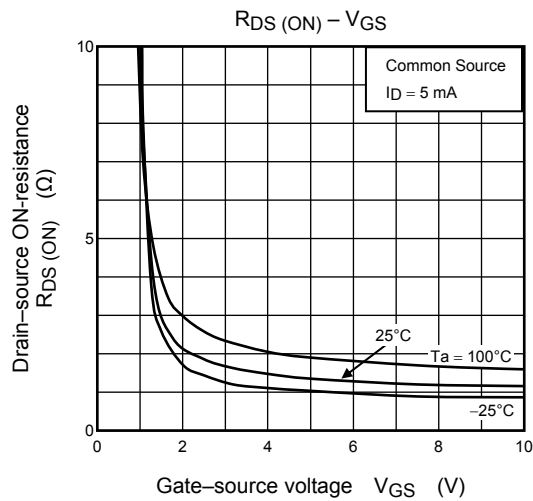
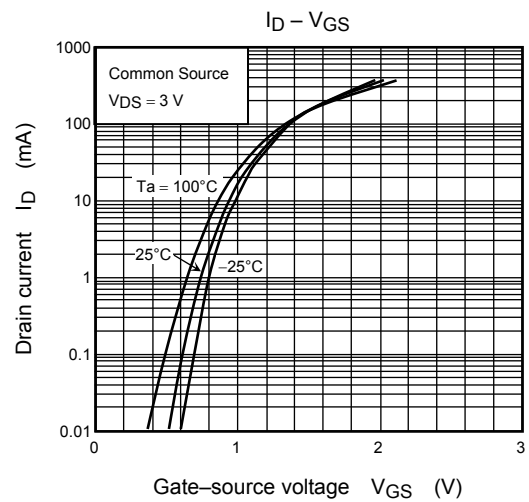
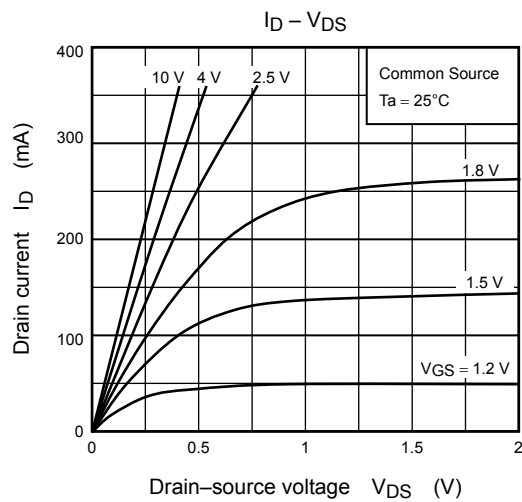
Usage Considerations

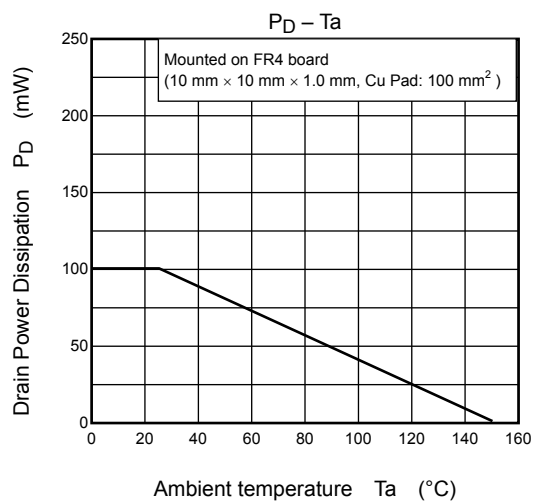
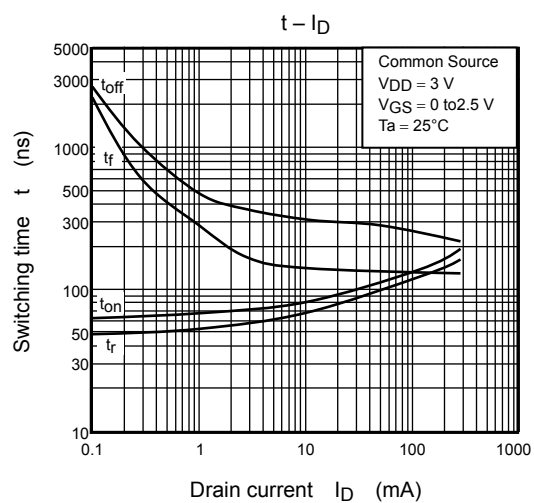
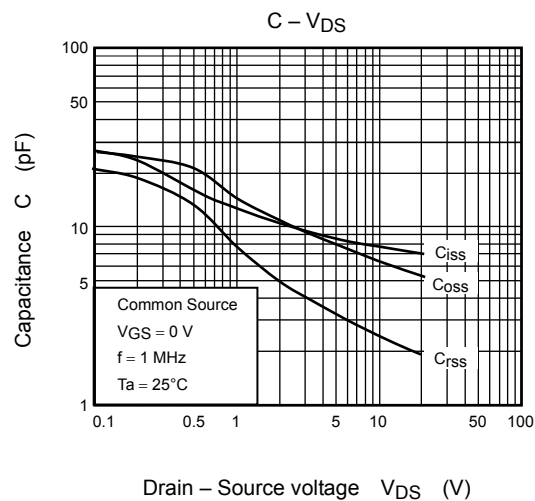
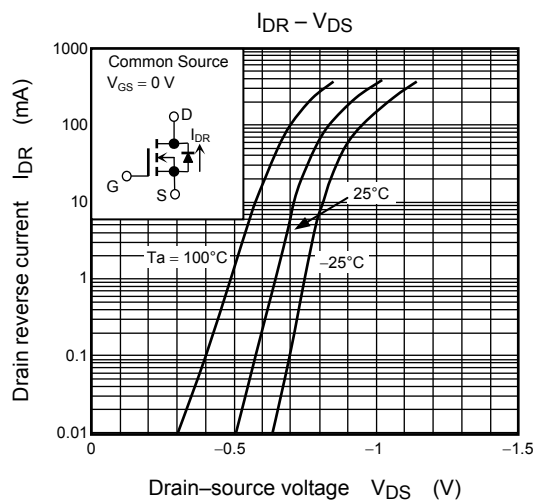
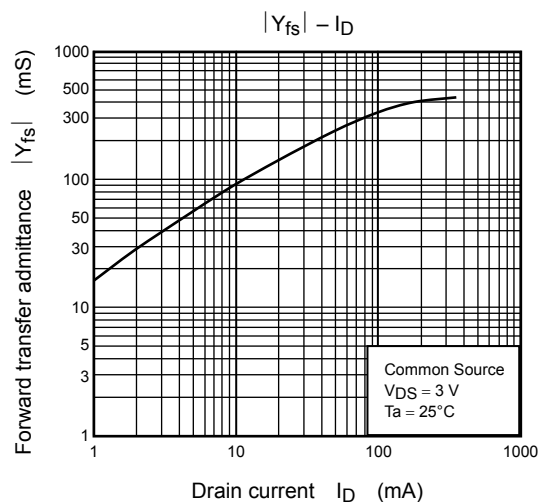
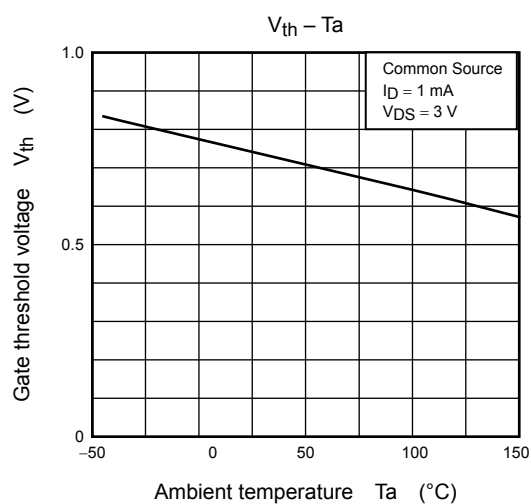
Let V_{th} be the voltage applied between gate and source that causes the drain current (I_D) to be below (1 mA for the SSM3K35CT). Then, for normal switching operation, $V_{GS(on)}$ must be higher than V_{th} , and $V_{GS(off)}$ must be lower than V_{th} . This relationship can be expressed as: $V_{GS(off)} < V_{th} < V_{GS(on)}$.

Take this into consideration when using the device.

Handling Precaution

When handling individual devices (which are not yet mounting on a circuit board), be sure that the environment is protected against electrostatic electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.





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